

BRIGHT LED ELECTRONICS CORP.

LED LAMPS SPECIFICATION

●COMMODITY : AXIAL TYPE LAMP

●DEVICE NUMBER : BL-XG0361-F8

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●ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta=25°C)

REVISION: 1.1

Chip			Lens Appearance	Absolute Maximum Rating				Electro-optical Data (At 20mA)				Viewing Angle 2θ 1/2 (deg)
Emitted Color	Peak Wave Length λ p(nm)	Dominant Wave Length λ d(nm)		Δ λ (nm)	Pd (mW)	If (mA)	Peak If(mA)	Vf(V)		Iv. (mcd)		
								Typ.	Max.	Min	Typ.	
Yellow Green	568	571±5	Water Clear	30	80	30	150	2.1	2.6	18.5	45.0	35

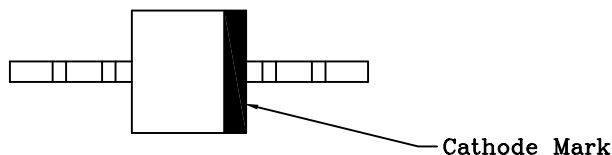
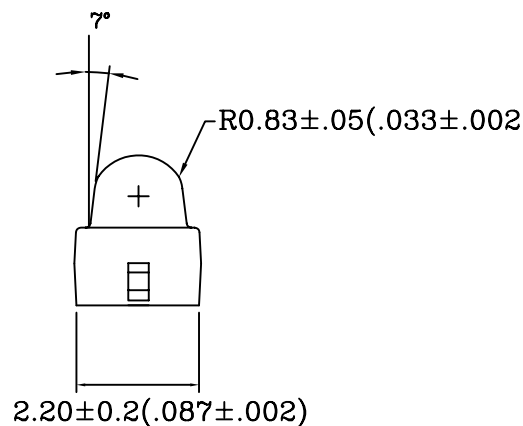
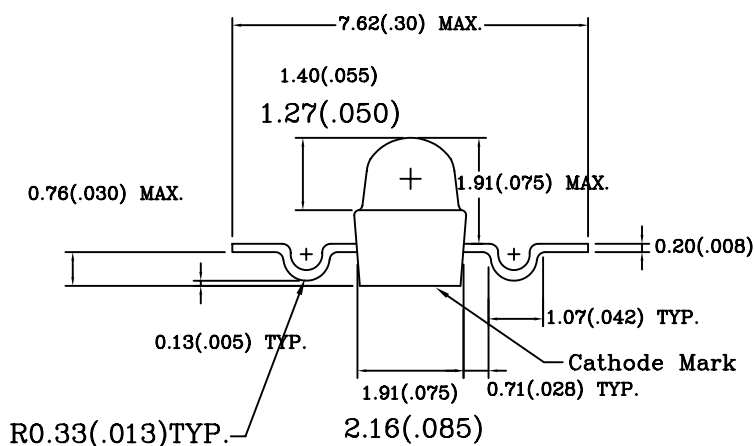
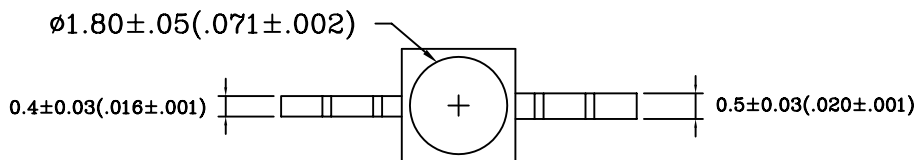
Remark : 1.Viewing angle is the Off-axis angle at which the luminous intensity is half the axial luminous intensity.

2.This product doesn't contain restriction substance, comply ROHS standard.

●ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Reverse Voltage	5V
Reverse Current (V _R =5V)	100μA
Operating Temperature Range	-25°C ~ 80°C
Storage Temperature Range	-30°C ~ 100°C
Lead Soldering Temperature	260°C For 5 Seconds

●PACKAGE DIMENSIONS



NOTES: 1.All dimensions are in millimeters (inches).

2.Tolerance is ±0.25mm (0.01") unless otherwise specified.

3.Lead spacing is measured where the leads emerge from the package.

4.Specifications are subject to change without notice.

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Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

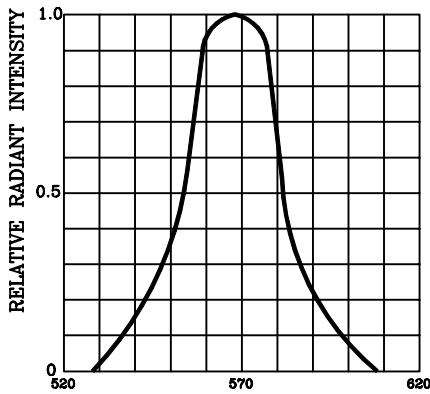


Fig.2 FORWARD CURRENT DERATING CURVE

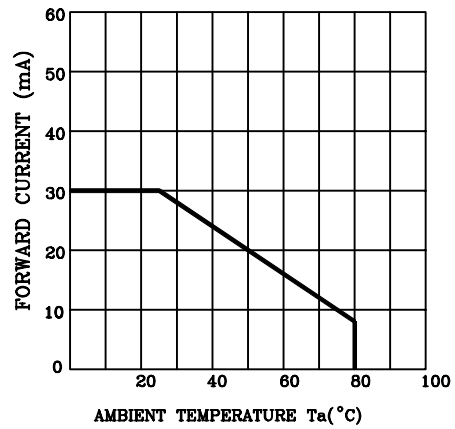


Fig.3 FORWARD CURRENT VS. FORWARD VOLTAGE

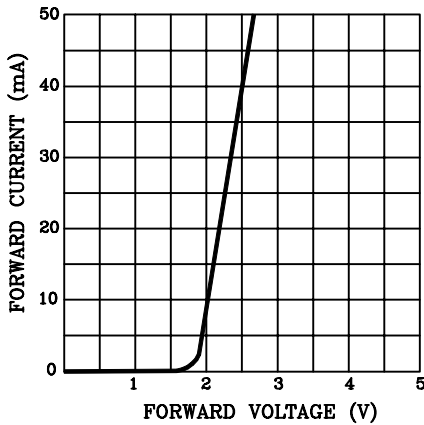


Fig.4 RELATIVE LUMINOUS INTENSITY VS. AMBIENT TEMPERATURE

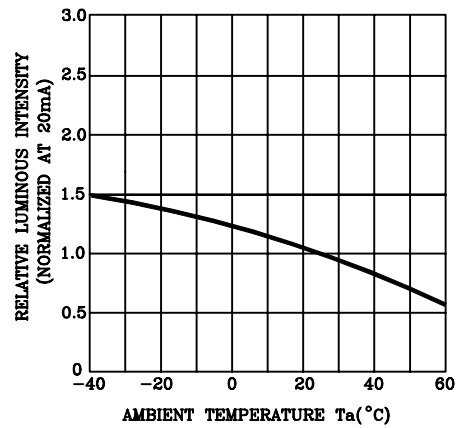


Fig.5 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

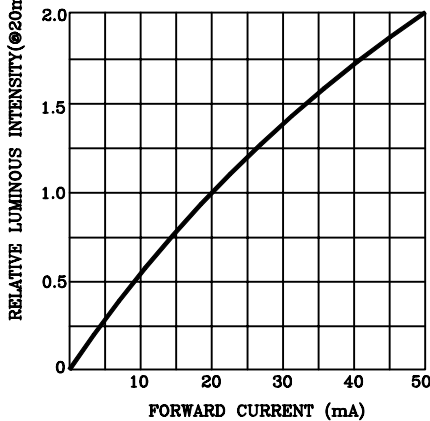
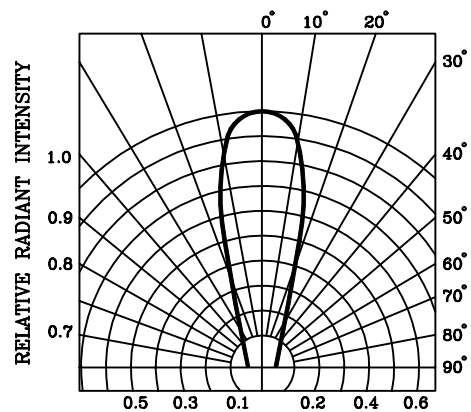


Fig.6 RADIATION DIAGRAM



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AXIAL LED LAMP SPECIFICATION

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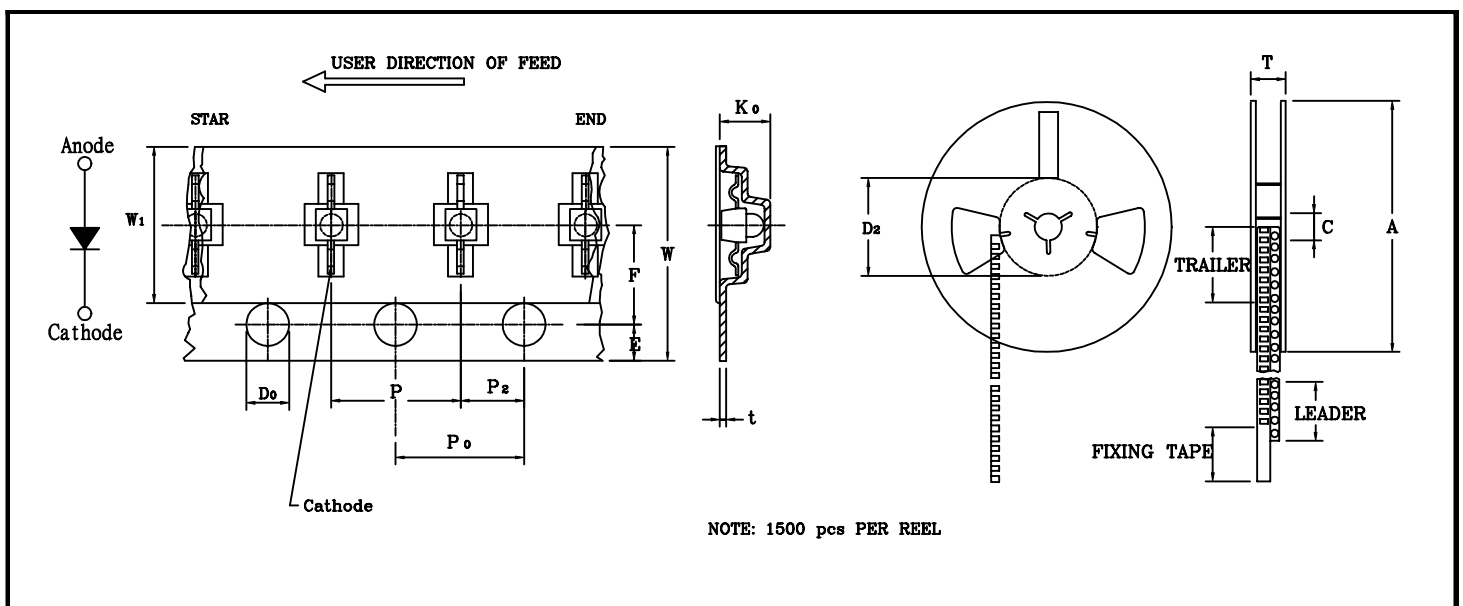
● DEVICE NUMBER : BL-XG0361-TR8

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● TAPPING AND PACKAGING SPECIFICATION

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ITEM	SYMBOL	SPECIFICATION			
		Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter (DIA)	D_0	1.40	0.055	1.55	0.061
Feed Hole Location	E	1.65	0.065	1.85	0.072
Centers Line Dimensions Length Direction	F	5.45	0.215	5.55	0.218
Compartment Depth	K_0	3.02	0.119	3.22	0.127
Carrier Tape Overall Thickness	K	3.00	0.118	3.20	0.126
Compartment Pitch	P	3.90	0.153	4.10	0.161
Sprocket Hole Diameter	P_0	3.90	0.153	4.10	0.161
Centers Line Dimensions Length Direction	P_2	1.95	0.076	2.05	0.080
Carrier Tape Thickness	t	—	—	0.30	0.012
Carrier Tape Width	W	12.00	0.472	12.30	0.484
Flange Diameter	A	178.0	7.008	180.0	7.087
Hub Spindle Hole	C	12.50	0.492	13.50	0.531
Hub Diameter	D_2	20.00	0.788	21.50	0.846
Fixing Tape Width	W_1	9.00	0.354	9.30	0.366
Flange Space Between Flanges	T	16.00	0.629	17.00	0.669
Compartment Length	A_0	2.29	0.090	2.49	0.098
Compartment Width	B_0	7.62	0.300	7.82	0.308



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SURFACE MOUNT CHIP LED LAMP SPECIFICATION

RELIABILITY TEST

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Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS C 7021 :B-1	Connect with a power $I_f=20\text{mA}$ T_a =Under room temperature Test time=1,000hrs	0/20
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS C 7021 :B-11	$T_a=+65^\circ\text{C}\pm 5^\circ\text{C}$ RH=90%-95% Test time=240hrs	0/20
	High Temperature Storage	MIL-STD-883:1008 JIS C 7021 :B-10	High $T_a=+85^\circ\text{C}\pm 5^\circ\text{C}$ Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low $T_a=-35^\circ\text{C}\pm 5^\circ\text{C}$ Test time=1,000hrs	0/20
Environmental Test	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS C 7021 :A-4	$-35^\circ\text{C} \sim +25^\circ\text{C} \sim +85^\circ\text{C} \sim +25^\circ\text{C}$ 60min 20min 60min 20min Test Time=5cycle	0/20
	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	$-35^\circ\text{C}\pm 5^\circ\text{C} \sim +85^\circ\text{C}\pm 5^\circ\text{C}$ 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS C 7021 :A-1	Preheating : $140^\circ\text{C} - 160^\circ\text{C}$, within 2 minutes. Operation heating : 235°C (Max.), within 10seconds. (Max.)	0/20

JUDGMENT CRITERIA OF FAILURE FOR THE RELIABILITY

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	V_F (V)	$I_f=20\text{mA}$	Over $U_x1.2$
Reverse current	I_r (μA)	$V_r=5\text{V}$	Over U_x2
Luminous intensity	I_v (mcd)	$I_f=20\text{mA}$	Below $SX0.5$

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

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1. SOLDERING:

● Manual Of Soldering

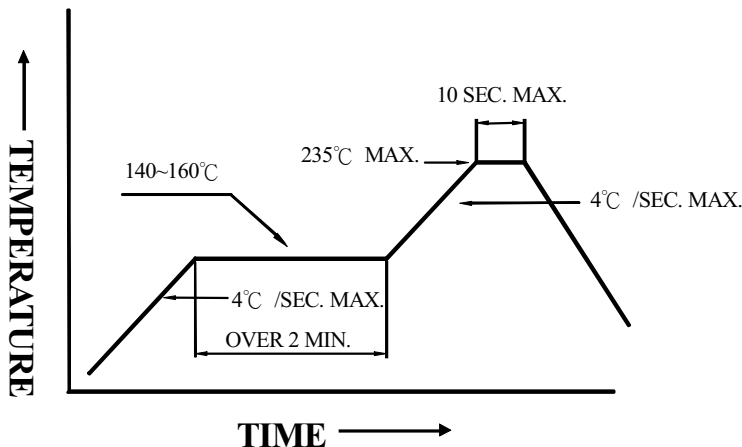
The temperature of the iron tip should not be higher than 300°C (572°F) and Soldering within 3 seconds per solder-land is to be observed.

● Reflow Soldering

Preheating : 140°C~160°C±5°C, within 2 minutes.

Operation heating : 235°C (MAX.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).

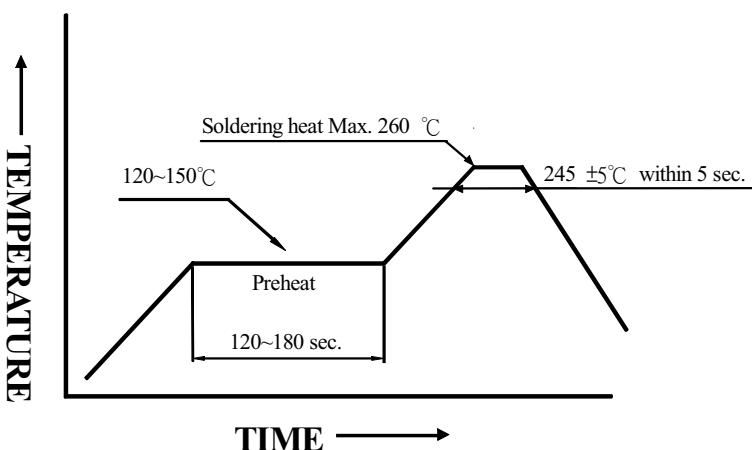


● DIP soldering (Wave Soldering)

Preheating : 120°C~150°C, within 120~180 sec.

Operation heating : 245°C±5°C within 5 sec. 260°C (Max)

Gradual Cooling (Avoid quenching).



2. Handling :

Care must be taken not to cause to the epoxy resin portion of BRIGHT LEDs while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of BRIGHT LEDs with hard or sharp article such as the sand blast and the metal hook.

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3. Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the BRIGHT LEDs within the rated figures. Also, caution should be taken not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as to be subjected to reverse voltage when turning off the BRIGHT LEDs.

4. Package and Label of Products:

(1) Package: Products are packed in one bag of 1500 pcs (one taping reel) and a label is attached on each bag.

(2) Label:

